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January 1996 Revised August 2004

NC7S14

TinyLogic® HS Inverter with Schmitt Trigger Input

General Description

The NC7S14 is a single high performance CMOS Inverter with Schmitt Trigger input. The circuit design provides hysteresis between the positive-going and negative going input thresholds thereby improving noise margins.

Advanced Silicon Gate CMOS fabrication assures high speed and low power circuit operation over a broad $\rm V_{CC}$ range. ESD protection diodes inherently guard both input and output with respect to the $\rm V_{CC}$ and GND rails.

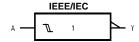
Features

- Space saving SOT23 or SC70 5-lead package
- Ultra small MicroPak™ leadless package
- Schmitt input hysteresis: > 1V typ
- High speed: t_{PD} 4.5 ns typ
- \blacksquare Low quiescent power: $I_{CC} < 1 \mu A$
- Balanced output drive: 2 mA I_{OL}, -2 mA I_{OH}
- Broad V_{CC} operating range: 2V 6V
- Balanced propagation delays
- Specified for 3V operation

Ordering Code:

Order Number	Package Number	Package Top Mark	Package Description	Supplied As
NC7S14M5X	MA05B	7S14	5-Lead SOT23, JEDEC MO-178, 1.6mm	3k Units on Tape and Reel
NC7S14P5X	MAA05A	S14	5-Lead SC70, EIAJ SC-88a, 1.25mm Wide	3k Units on Tape and Reel
NC7S14L6X	MAC06A	UU	6-Lead MicroPak, 1.0mm Wide	5k Units on Tape and Reel

Logic Symbol



Pin Descriptions

Pin Names	Description
Α	Input
Υ	Output
NC	No Connect

Function Table

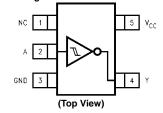
$$Y = \overline{A}$$

Input	Output
Α	Y
L	Н
Н	L

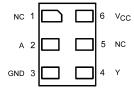
H = HIGH Logic Level L = LOW Logic Level

Connection Diagrams

Pin Assignments for SC70 and SOT23



Pad Assignments for MicroPak



(Top Thru View)

 $\label{eq:total_cond} \mbox{TinyLogic@ is a registered trademark of Fairchild Semiconductor Corporation.} \\ \mbox{MicroPak}^{\mbox{\tiny TM}} \mbox{ is a trademark of Fairchild Semiconductor Corporation.} \\$

Absolute Maximum Ratings(Note 1) **Recommended Operating**

-0.5V to +7.0V Supply Voltage (V_{CC}) DC Input Diode Current (I_{IK})

 $@V_{IN} \le -0.5V$ -20 mA $@V_{IN} \ge V_{CC} + 0.5V$ +20 mA DC Input Voltage (V_{IN}) -0.5V to V_{CC} +0.5V

DC Output Diode Current (I_{OK})

 $@V_{OUT} < -0.5V$ -20 mA $@V_{OUT} > V_{CC} + 0.5V$ +20 mA

DC Output Voltage (V_{OUT}) -0.5V to V_{CC} +0.5V

DC Output Source or Sink

Current (I_{OUT}) $\pm 12.5~\text{mA}$

DC V_{CC} or Ground Current per

Output Pin (I_{CC} or I_{GND}) ±25 mA

-65°C to +150°C Storage Temperature (T_{STG}) Junction Temperature (T_J) 150°C

Lead Temperature (T_L)

(Soldering, 10 seconds) 260°C

Power Dissipation (P_D) @ $+85^{\circ}$ C

SOT23-5 200 mW SC70-5 150 mW

Conditions (Note 2)

Supply Voltage (V_{CC}) 2.0V to 6.0V Input Voltage (V_{IN}) 0V to V_{CC} Output Voltage (V_{OUT}) 0V to V_{CC} Operating Temperature (T_A) -40° C to $+85^{\circ}$ C

Thermal Resistance (θ_{JA})

SOT23-5 300°C/W SC70-5 425°C/W

Note 1: Absolute maximum ratings are those values beyond which damage to the device may occur. The databook specifications should be met, without exception, to ensure that the system design is reliable over its power supply, temperature, and output/input loading variables. Fairchild does not recommend operation of circuits outside the databook specifications.

Note 2: Unused inputs must be held HIGH or LOW. They may not float.

DC Electrical Characteristics

Symbol	Parameter	v _{cc}		T _A = +25°C	;	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$		Units	Conditions
Syllibol	Parameter	(V)	Min	Тур	Max	Min	Max	Units	Conditions
V _P	Positive Threshold Voltage	2.0	1.0	1.29	1.5	1.0	1.6		
		3.0	1.5	1.90	2.2	1.5	2.2	٧	
		4.5	2.3	2.73	3.15	2.3	3.15	v	
		6.0	3.0	3.56	4.2	3.0	4.2		
V _N	Negative Threshold Voltage	2.0	0.3	0.70	0.9	0.3	0.9		
		3.0	0.6	1.05	1.35	0.6	1.35	٧	
		4.5	1.13	1.66	2.0	1.13	2.0	V	
		6.0	1.5	2.24	2.6	1.5	2.6		
V _H	Hysteresis Voltage	2.0	0.3	0.59	1.0	0.3	1.0		
		3.0	0.4	0.85	1.3	0.4	1.3	V	
		4.5	0.6	1.08	1.4	0.6	1.4	V	
		6.0	0.8	1.31	1.7	0.8	1.7		
V _{OH}	HIGH Level Output Voltage	2.0	1.90	2.0		1.90			
		3.0	2.90	3.0		2.90		V	$I_{OH} = -20 \mu A$ $V_{IN} = V_{IL}$
		4.5	4.40	4.5		4.40		V	$V_{IN} = V_{IL}$
		6.0	5.90	6.0		5.90			
									$V_{IN} = V_{IL}$
		3.0	2.68	2.87		2.63		V	$I_{OH} = -1.3 \text{ mA}$
		4.5	4.18	4.37		4.13		v	$I_{OH} = -2 \text{ mA}$
		6.0	5.68	5.86		5.63			$I_{OH} = -2.6 \text{ mA}$
V _{OL}	LOW Level Output Voltage	2.0		0.0	0.10		0.10		
		3.0		0.0	0.10		0.10	V	$I_{OH} = 20 \mu A$
		4.5		0.0	0.10		0.10	v	$V_{IN} = V_{IH}$
		6.0		0.0	0.10		0.10		
									$V_{IN} = V_{IH}$
		3.0		0.1	0.26		0.33	V	I _{OL} = 1.3 mA
		4.5		0.1	0.26		0.33	v	$I_{OL} = 2 \text{ mA}$
		6.0		0.1	0.26		0.33		I _{OL} = 2.6 mA

DC Electrical Characteristics (Continued)

Symbol	Parameter	V _{CC}	$T_A = +25^{\circ}C$		$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$		Units	Conditions		
- Cyllibol	T di dillotoi	(V)	Min	Тур	Max	Min	Max	Oillio	Conditions	
I _{IN}	Input Leakage Current	6.0			±0.1		±1.0	μΑ	$V_{IN} = V_{CC}$, GND	
I _{CC}	Quiescent Supply Current	6.0			1.0		10.0	μΑ	$V_{IN} = V_{CC}$, GND	

AC Electrical Characteristics

Symbol	Parameter	v _{cc}		$T_A = +25^{\circ}C$		$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$		Units	Conditions	Figure
2,	1 diameter	(V)	Min	Тур	Max	Min	Max	Oiiita	Conditions	Number
t _{PLH}	Propagation Delay	5.0		4.5	21			ns	C _L = 15 pF	
t _{PHL}		2.0		20	100		125		C _L = 50 pF	T
		3.0		12	27		35			Figures 1, 3
		4.5		8.5	20		25	ns		
		6.0		7.5	17		21			
t _{TLH}	Output Transition Time	5.0		3	8			ns	C _L = 15 pF	
t _{THL}		2.0		25	125		145		C _L = 50 pF	T
		3.0		16	35		45	ns		Figures 1, 3
		4.5		11	25		30	ns		1,0
		6.0		9	21		24			
C _{IN}	Input Capacitance	Open		2	10		10	pF		
C _{PD}	Power Dissipation Capacitance	5.0		7				pF	(Note 3)	Figure 2

Note 3: C_{PD} is defined as the value of the internal equivalent capacitance which is derived from dynamic operating current consumption (I_{CCD}) at no output loading and operating at 50% duty cycle. (See Figure 2.) C_{PD} is related to I_{CCD} dynamic operating current by the expression: $I_{CCD} = (C_{PD}) \ (V_{CC}) \ (f_{IN}) + (I_{CC} static)$.

AC Loading and Waveforms



C_L includes load and stray capacitance

Input PRR = 1.0 MHz, $t_w = 500 \text{ ns}$

FIGURE 1. AC Test Circuit



Input = AC Waveforms;

PRR = variable; Duty Cycle = 50%

FIGURE 2. $I_{\rm CCD}$ Test Circuit

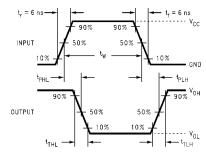


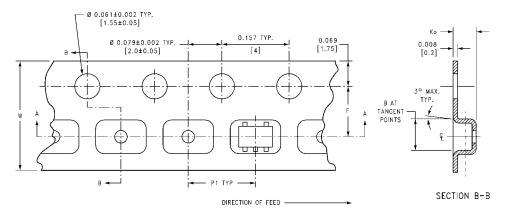
FIGURE 3. AC Waveforms

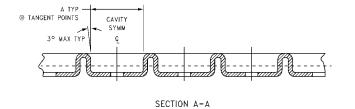
Tape and Reel Specification

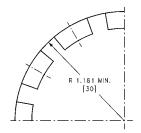
TAPE FORMAT for SC70 and SOT23

Package	Tape	Number	Cavity	Cover Tape	
Designator	Section	Cavities	Status	Status	
	Leader (Start End)	125 (typ)	Empty	Sealed	
M5X, P5X	Carrier	3000	Filled	Sealed	
	Trailer (Hub End)	75 (typ)	Empty	Sealed	

TAPE DIMENSIONS inches (millimeters)



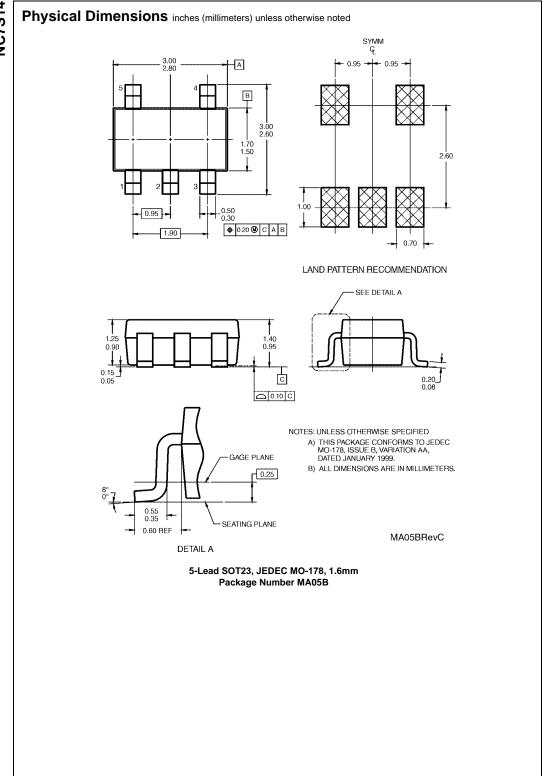




BEND RADIUS NOT TO SCALE

Package	Tape Size	DIM A	DIM B	DIM F	DIM K _o	DIM P1	DIM W
SC70-5	8 mm	0.093	0.096	0.138 ±0.004	0.053 ±0.004	0.157	0.315 ±0.004
		(2.35)	(2.45)	(3.5 ±0.10)	(1.35 ±0.10)	(4)	(8 ±0.1)
SOT22 5	9 mm	0.130	0.130	0.138 ±0.002	0.055 ±0.004	0.157	0.315 ±0.012
SOT23-5	8 mm	(3.3)	(3.3)	(3.5 ±0.05)	(1.4 ±0.11)	(4)	(8 ±0.3)

Tape and Reel Specification (Continued) TAPE FORMAT for MircoPak Package Tape Number Cavity Cover Tape Designator Section Cavities Status Status Leader (Start End) 125 (typ) Empty Sealed L6X Carrier 5000 Filled Sealed Trailer (Hub End) 75 (typ) **Empty** Sealed 2.00-1.75±0.10 В 8.00 ^{+0.30} -0.10 3.50±0.05 1.15±0.05 **-** → В◄ -ø 0.50 ±0.05 SECTION B-B DIRECTION OF FEED SCALE:10X 0.254±0.020 Г 0.70±0.05 SECTION A-A SCALE:10X **REEL DIMENSIONS** inches (millimeters) TAPE SLOT DETAIL X **DETAIL X** SCALE: 3X Tape Α В С D N W1 W2 W3 Size 2.165 0.331 +0.059/-0.000 0.567 W1 +0.078/-0.039 0.059 0.512 0.795 8 mm (177.8)(1.50)(13.00)(20.20)(55.00)(8.40 +1.50/-0.00) (14.40)(W1 +2.00/-1.00)



Physical Dimensions inches (millimeters) unless otherwise noted (Continued) 2.00±0.20 0.65 1.9 B- 1.25±0.10 2.10±0.10 0.4 min -0.20 ^{+0.10} -0.05 0.25 LAND PATTERN RECOMMENDATION ♦ max 0.1 **⊗** SEE DETAIL A 0.9±.10 0.95±0.15 max 0.1 R0.14 GAGE PLANE R0.10 0.20 0.45 0.10 - 0.425 NOMINAL DETAIL A

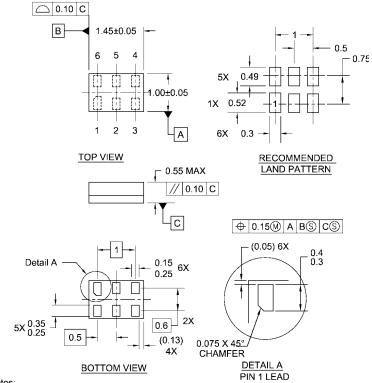
NOTES:

A. CONFORMS TO EIAJ REGISTERED OUTLINE DRAWING SC88A.
B. DIMENSIONS DO NOT INCLUDE BURRS OR MOLD FLASH.
C. DIMENSIONS ARE IN MILLIMETERS.

MAA05ARevC

5-Lead SC70, EIAJ SC-88a, 1.25mm Wide Package Number MAA05A

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



Notes:

- 1. JEDEC PACKAGE REGISTRATION IS ANTICIPATED 2. DIMENSIONS ARE IN MILLIMETERS
- 3. DRAWING CONFORMS TO ASME Y14.5M-1994

MAC06ARevB

6-Lead MicroPak, 1.0mm Wide Package Number MAC06A

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